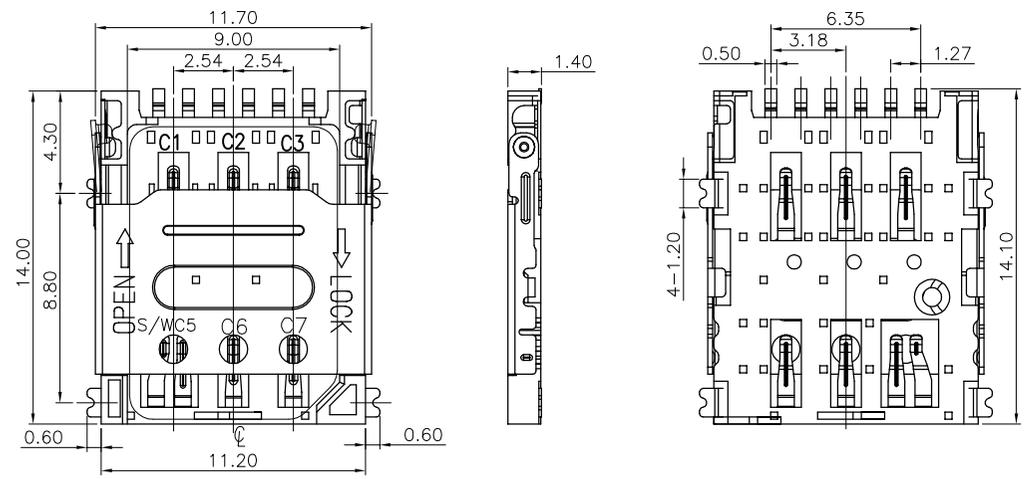
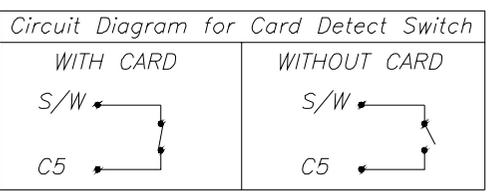
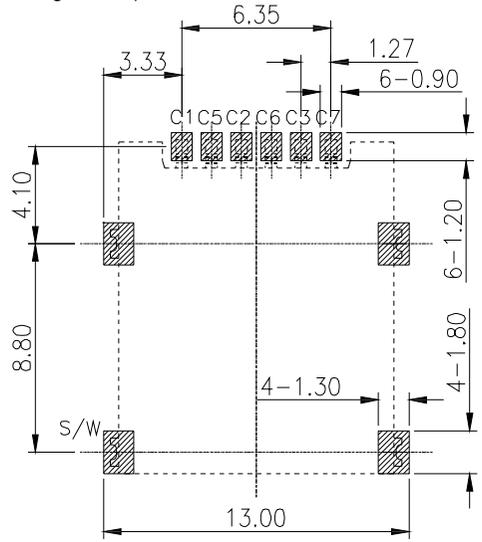
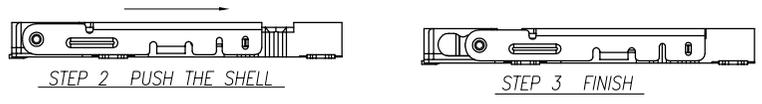
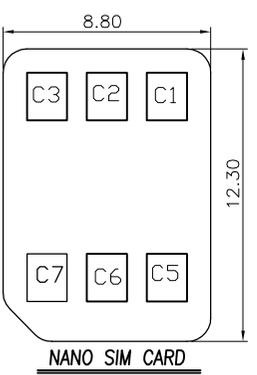
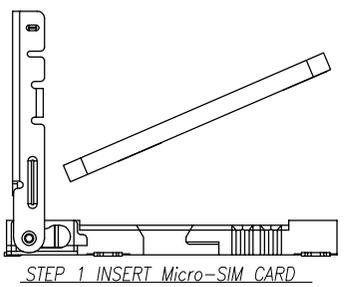
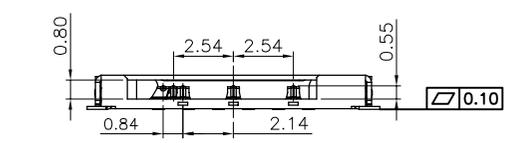


REV.	DATE	ECN.NO	MODIFY.CONTENT	APPROVER
A	2017.07.25		初版发行	Jason
B	2019.12.03		依实物修改图纸	Jason
C	2020.11.11	RD00320111101	更新图纸	Jason



Specifications:
Material:
 1.Housing: Thermoplastics,UL94V-0
 2.Contact: Copper Alloy Gold plated in contact area; Gold plated on solder area Plated Nickel overall
 3.Peg: Gold plated on solder area.
 4.Shell: SUS
Electrical:
 1.Current Rating: 0.5A
 2.Voltage Rating: 100V DC
 3.Contact Resistance: 80 mΩ MAX
 4.Dielectric Withstanding Voltage: 100 V AC for one minute
 5.Insulation Resistance: 100 MΩ MIN

Environment characteristics:
 1.Operating Temperature: -30°C~+85°C



PIN NO.	PIN NAME
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O
S/W	Switch Pin

GENERAL TOLERANCE				UNITS	NAME(INTENDED USE)	
SELECT	✓			mm	卡座	
TOL				MAT'L	PART NO.(INTENDED USE)	
ON.	1	2	3		SI80C-03200	
X.XXX	±0.15	±0.05	±0.15	FINISH	TITLE: CUSTOMER DRAWING FOR	
X.XX	±0.25	±0.13	±0.25		NANO SIM CARD 6P SMT H=1.4mm 掀盖式 卷装	
X.X	±0.30	±0.25	±0.50	Q'TY	APPD: Jason	DWG NO.:
X.	±0.38	±0.38	±1.00		CHKD: ABEL	ATOM-A04397
ANGLE	±5°			DR: hujing	SCALE SHEET REV.	
					1:1	1/1 c

ATOM 深圳市爱特姆科技有限公司
 SHENZHEN ATOM TECHNOLOGY CO., LTD.